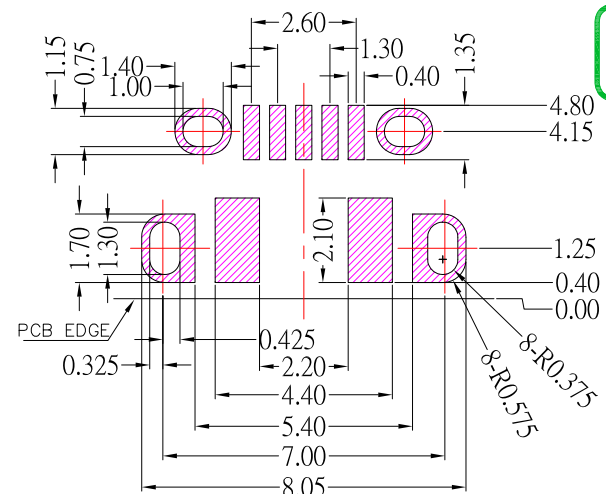
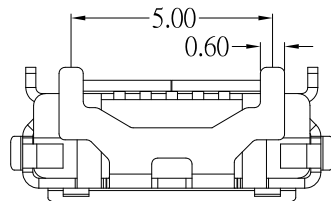




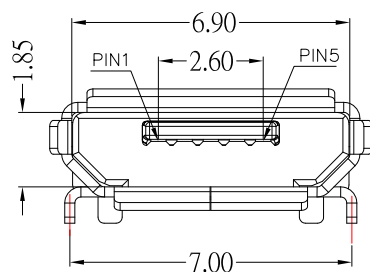
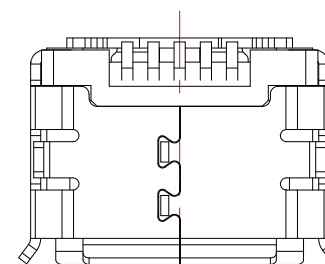
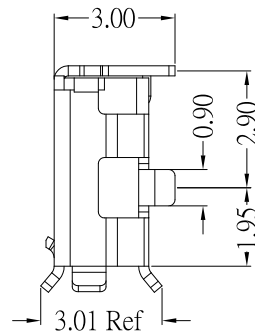
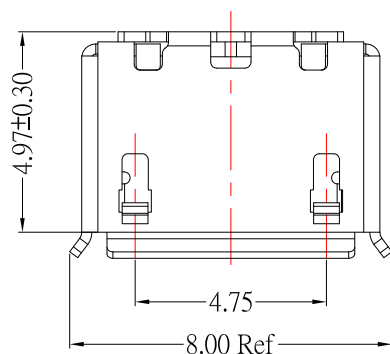
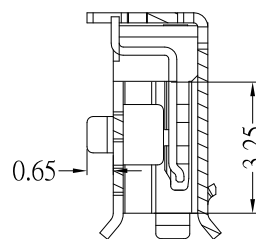
MRUSB-5B-D16x-S347

SHELL 鍍層:

TN
NI



P.C.B LAYOUT MOUNTING PATTERN



NOTES:

1.MATERIAL:

- 1.1 HOUSING: LCP
- 1.2 CONTACT: PHOSPHOR BRONZE
- 1.3 SHELL: SUS

2.Finish:

- 2.1 Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall
- 2.2 SHELL: NICKEL or TIN UNDER PLATED SURFACE LAYER

3.SPECIFICATION:

- 3.1 CURRENT RATING: 1.8 A Max(PIN1,5)
1.0 A Max(PIN2,3,4)
- 3.2 DIELECTRIC WITHSTANDING VOLTAGE: 100 V(ac) FOR 1min
- 3.3 CONTACT RESISTANCE: 30 mΩ MAX.
- 3.4 INSULATION RESISTANCE: 100 MΩ MIN.
- 3.5 TOTAL MATING FORCE: 3.57 KgF MAX.
- 3.6 TOTAL UNMATING FORCE: 1.0 KgF MIN.
- 3.7 TEMPERATURE RANGE: -30°C ~ +80°C

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED:
Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3

3RD. ANGEL'S



UNITS MM

DRAWN BY:	DATE	MAT'L	TITLE	CONNECTOR
Jack Lu	09/22/20			
CHECKED BY:	DATE	FINISH	MODLE	MICRO USB 5P SMT 牛角型後蓋 PH:7.0-5.0mm
Jacky Chen	09/22/20			
APPROVED BY:	DATE	SCALE	DWG NO.	MRUSB-5B-D16x-S347
Tony Kao	09/22/20	1 : 1		
		SHEET NO.	PART NO.	MRUSB-5B-D16x-S347
		1 of 1		

1	更新樣式	Jack	092220
ITEM NO.	DESCRIPTION	DRAWN	DATE